## **PMLL4148L**; **PMLL4448**

# High-speed switching diodes Rev. 8 — 1 February 2011

Product data sheet

#### **Product profile** 1.

#### 1.1 General description

Single high-speed switching diodes, fabricated in planar technology, and encapsulated in small hermetically sealed glass SOD80C Surface-Mounted Device (SMD) packages.

Table 1. **Product overview** 

Type number	Package	Configuration
PMLL4148L	SOD80C	single
PMLL4448		

#### 1.2 Features and benefits

■ High switching speed:  $t_{rr} \le 4$  ns

Reverse voltage: V<sub>R</sub> ≤ 75 V

Repetitive peak reverse voltage: V<sub>RRM</sub> ≤ 100 V Repetitive peak forward current: I<sub>FRM</sub> ≤ 450 mA Small hermetically sealed glass SMD package

### 1.3 Applications

- High-speed switching
- Reverse polarity protection

#### 1.4 Quick reference data

Quick reference data Table 2.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I <sub>F</sub>	forward current		<u>[1]</u> -	-	200	mA
I <sub>FRM</sub>	repetitive peak forward current		-	-	450	mA
$V_R$	reverse voltage		-	-	75	V
V <sub>F</sub>	forward voltage					
	PMLL4148L	$I_F = 50 \text{ mA}$	-	-	1	V
	PMLL4448	$I_F = 5 \text{ mA}$	620	-	720	mV
		$I_F = 100 \text{ mA}$	-	-	1	V
t <sub>rr</sub>	reverse recovery time		[2] _	-	4	ns

<sup>[1]</sup> Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard

<sup>[2]</sup> When switched from  $I_F = 10$  mA to  $I_R = 60$  mA;  $R_L = 100$   $\Omega$ ; measured at  $I_R = 1$  mA.



### 2. Pinning information

Table 3. Pinning

Pin	Description	Simplified outline	Graphic symbol
1	cathode	[1]	1.4
2	anode	k	**
			sym006

<sup>[1]</sup> The marking band indicates the cathode.

### 3. Ordering information

Table 4. Ordering information

Type number	Package		
	Name	Description	Version
PMLL4148L	-	hermetically sealed glass surface-mounted package;	SOD80C
PMLL4448		2 connectors	

### 4. Marking

Table 5. Marking codes

Type number	Marking code
PMLL4148L	marking band
PMLL4448	marking band

### 5. Limiting values

Table 6. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{RRM}$	repetitive peak reverse voltage		-	100	V
$V_R$	reverse voltage		-	75	V
I <sub>F</sub>	forward current		<u>[1]</u> -	200	mA
I <sub>FRM</sub>	repetitive peak forward current		-	450	mA
I <sub>FSM</sub>	non-repetitive peak forward	square wave	[2]		
	current	t <sub>p</sub> = 1 μs	-	4	Α
		$t_p = 1 \text{ ms}$	-	1	Α
		$t_p = 1 s$	-	0.5	А

 Table 6.
 Limiting values ...continued

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
P <sub>tot</sub>	total power dissipation	$T_{amb} = 25  ^{\circ}C$	<u>[1]</u> _	500	mW
Tj	junction temperature		-	200	°C
T <sub>amb</sub>	ambient temperature		-65	+200	°C
T <sub>stg</sub>	storage temperature		-65	+200	°C

<sup>[1]</sup> Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

### 6. Thermal characteristics

Table 7. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	<u>[1]</u> _	-	350	K/W
$R_{th(j-sp)}$	thermal resistance from junction to solder point		-	-	300	K/W

<sup>[1]</sup> Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

### 7. Characteristics

Table 8. Characteristics

 $T_{amb} = 25$  °C unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{F}$	forward voltage					
	PMLL4148L	$I_F = 50 \text{ mA}$	-	-	1	V
	PMLL4448	I <sub>F</sub> = 5 mA	620	-	720	mV
		I <sub>F</sub> = 100 mA	-	-	1	V
I <sub>R</sub>	reverse current	V <sub>R</sub> = 20 V	-	-	25	nA
		$V_R = 20 \text{ V}; T_j = 150 ^{\circ}\text{C}$	-	-	50	μΑ
I <sub>R</sub>	reverse current					
	PMLL4448	$V_R = 20 \text{ V}; T_j = 100 ^{\circ}\text{C}$	-	-	3	μΑ
$C_d$	diode capacitance	$V_R = 0 V$ ; $f = 1 MHz$	-	-	4	pF
t <sub>rr</sub>	reverse recovery time		[1] _	-	4	ns
$V_{FR}$	forward recovery voltage		[2] _	-	2.5	V

<sup>[1]</sup> When switched from  $I_F$  = 10 mA to  $I_R$  = 60 mA;  $R_L$  = 100  $\Omega;$  measured at  $I_R$  = 1 mA.

<sup>[2]</sup>  $T_i = 25$  °C prior to surge.

<sup>[2]</sup> When switched from  $I_F$  = 50 mA;  $t_r$  = 20 ns.

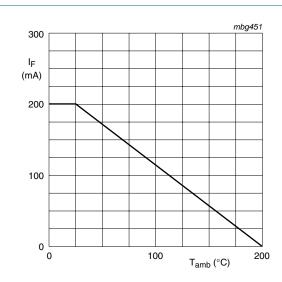
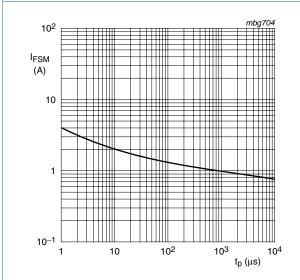


Fig 1. Forward current as a function of ambient temperature; derating curve

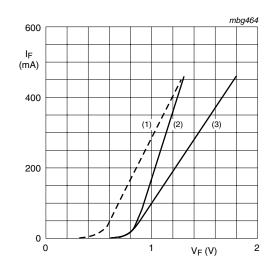
FR4 PCB, standard footprint



Based on square wave currents.

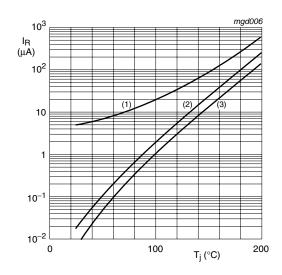
 $T_i = 25$  °C; prior to surge

Fig 3. Non-repetitive peak forward current as a function of pulse duration; maximum values



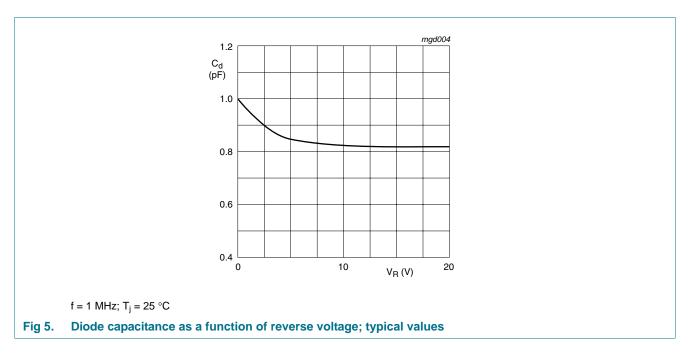
- (1)  $T_j = 175$  °C; typical values
- (2)  $T_i = 25 \,^{\circ}C$ ; typical values
- (3)  $T_i = 25 \,^{\circ}C$ ; maximum values

Fig 2. Forward current as a function of forward voltage

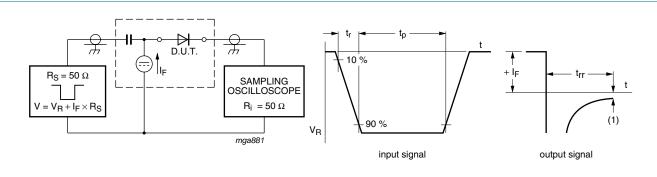


- (1) V<sub>R</sub> = 75 V; maximum values
- (2) V<sub>R</sub> = 75 V; typical values
- (3)  $V_R = 20 \text{ V}$ ; typical values

Fig 4. Reverse current as a function of junction temperature



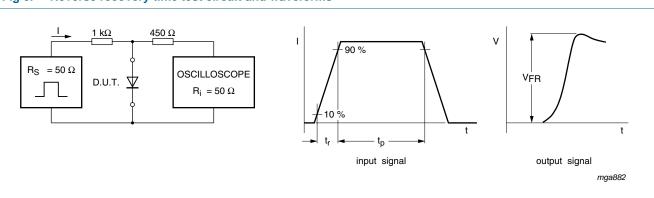
### 8. Test information



(1)  $I_R = 1 \text{ mA}$ 

Input signal: reverse pulse rise time  $t_r$  = 0.6 ns; reverse voltage pulse duration  $t_p$  = 100 ns; duty cycle  $\delta \le 0.05$  Oscilloscope: rise time  $t_r$  = 0.35 ns

Fig 6. Reverse recovery time test circuit and waveforms



Input signal: forward pulse rise time  $t_r$  = 20 ns; forward current pulse duration  $t_p \ge 100$  ns; duty cycle  $\delta \le 0.005$ 

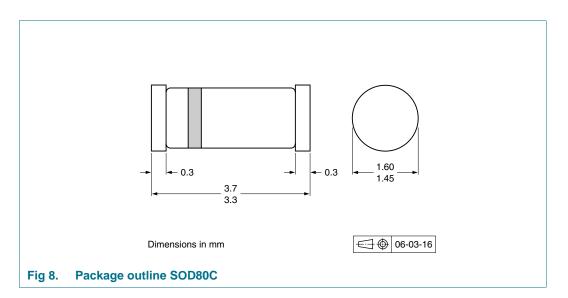
Fig 7. Forward recovery voltage test circuit and waveforms

PMLL4148L\_PMLL4448

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### 9. Package outline



### 10. Packing information

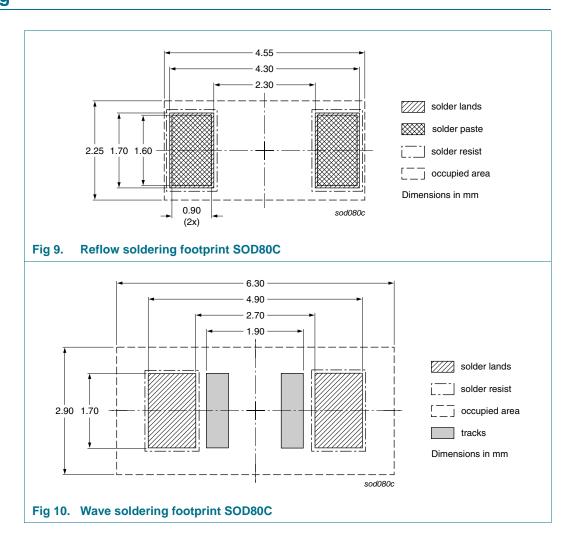
Table 9. Packing methods

The indicated -xxx are the last three digits of the 12NC ordering code.[1]

Type number	ype number Package Description		Packing o	Packing quantity		
			2500	10000		
PMLL4148L	SOD80C	4 mm pitch, 8 mm tape and reel	-115	-135		
PMLL4448						

<sup>[1]</sup> For further information and the availability of packing methods, see Section 14.

### 11. Soldering



### 12. Revision history

#### Table 10. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
PMLL4148L_PMLL4448 v.8	20110201	Product data sheet	-	PMLL4148L_PMLL4448 v.7
Modifications:	<ul> <li>Section 4 "M</li> </ul>	arking": amended.		
	• Figure 8: rep	laced by minimized outline of	drawing.	
	<ul><li>Section 13 "I</li></ul>	<u>egal information</u> ": updated.		
PMLL4148L_PMLL4448 v.7	20070131	Product data sheet	-	PMLL4148L_PMLL4448 v.6
PMLL4148L_PMLL4448 v.6	20050404	Product data sheet	-	PMLL4148L_4448 v.5
PMLL4148L_4448 v.5	20020123	Product specification	-	PMLL4148L_4448 v.4
PMLL4148L_4448 v.4	20001115	Product specification	-	PMLL4148 v.3
PMLL4148 v.3	19990527	Product specification	-	PMLL4148 v.2
PMLL4148 v.2	19960918	Product specification	-	PMLL4148 v.1
PMLL4148 v.1	19960423	Product specification	-	-

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#### 13.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions"
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### PMLL4148L; PMLL4448

#### **High-speed switching diodes**

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### 15. Contents

1	Product profile	1
1.1	General description	1
1.2	Features and benefits	1
1.3	Applications	1
1.4	Quick reference data	1
2	Pinning information	2
3	Ordering information	2
4	Marking	2
5	Limiting values	2
6	Thermal characteristics	3
7	Characteristics	3
8	Test information	5
9	Package outline	6
10	Packing information	6
11	Soldering	7
12	Revision history	8
13	Legal information	9
13.1	Data sheet status	Ĉ
13.2	Definitions	Ĉ
13.3	Disclaimers	
13.4	Trademarks1	C
14	Contact information 1	0
15	Contents	11

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